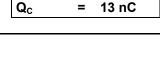
GeneSiC

Silicon Carbide Power **Schottky Diode**

Features

- 1200 V Schottky rectifier
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of V_F
- Extremely fast switching speeds
- Superior figure of merit Q_C/I_F

Package





RoHS Compliant



TO – 252

Advantages

- Improved circuit efficiency (Lower overall cost)
- · Low switching losses
- · Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- · Low reverse recovery current
- · Low device capacitance
- Low reverse leakage current at operating temperature

Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

Maximum Ratings at T_i = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit	
Repetitive peak reverse voltage	V _{RRM}		1200	V	
Continuous forward current	I _F	T _C ≤ 160 °C	1	А	
RMS forward current	I _{F(RMS)}	T _C ≤ 160 °C	2	А	
Surge non-repetitive forward current, Half Sine Wave	I _{F,SM}	T_{C} = 25 °C, t_{P} = 10 ms T_{C} = 160 °C, t_{P} = 10 ms	10 8	А	
Non-repetitive peak forward current	I _{F,max}	T _C = 25 °C, t _P = 10 μs	65	А	
²t value	∫i² dt	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	0.5	A ² s	
Power dissipation	P _{tot}	$T_{\rm C}$ = 160 °C, t _P = 10 ms $T_{\rm C}$ = 25 °C	0.3 42	W	
Operating and storage temperature	T _j , T _{stg}		-55 to 175	°C	

Electrical Characteristics at T_i = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions -		Values			Unit
Parameter				min.	typ.	max.	Unit
Diode forward voltage	V _F	I _F = 1 A, T _j = 25 °C I _F = 1 A, T _j = 175 °C		1.50	1.56	1.75	V
				2.29	2.39	3.68	
Reverse current	I _R	V _R = 1200 V, T _j	= 25 °C 0.2 0.4 4.		4.5	μA	
		V _R = 1200 V, T _j =	= 175 °C	0.5	1.0	11.3	μΑ
Total capacitive charge	Qc	1 4 1	V _R = 400 V		7 13		nC
			V _R = 960 V				
Switching time	ts	$T_j = 175 \ ^{\circ}C$	V _R = 400 V		< 17		ns
			V _R = 960 V				
Total capacitance	С	V _R = 1 V, f = 1 MHz, T _j = 25 °C V _R = 400 V, f = 1 MHz, T _j = 25 °C			69		pF
					10		
		V _R = 1000 V, f = 1 MH	lz, T _j = 25 °C	8			
Thermal Characteristics							
Thermal resistance, junction - case	R _{thJC}				3.6		°C/W
Mechanical Properties							
Mounting torque	М				0.6		Nm

GB01SLT12-252

=

=

=

=

1200 V

1.6 V

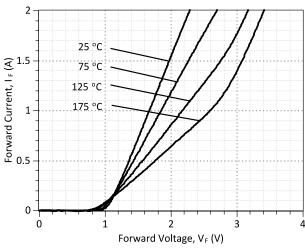
1 A

VRRM

VF

 I_{F}

GB01SLT12-252





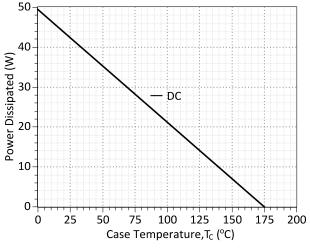
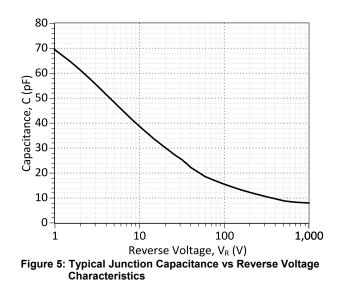


Figure 3: Power Derating Curve



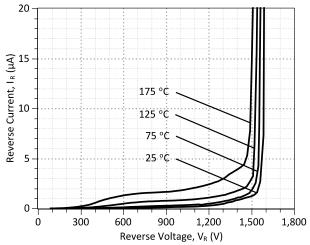
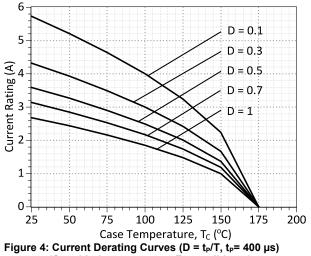
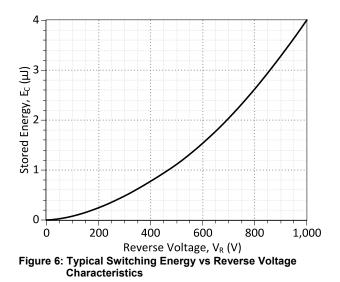


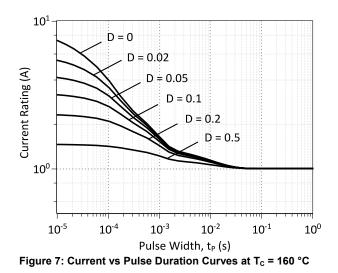
Figure 2: Typical Reverse Characteristics



(Considering worst case Z_{th} conditions)

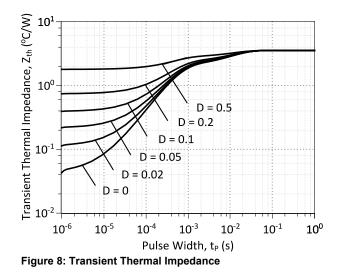


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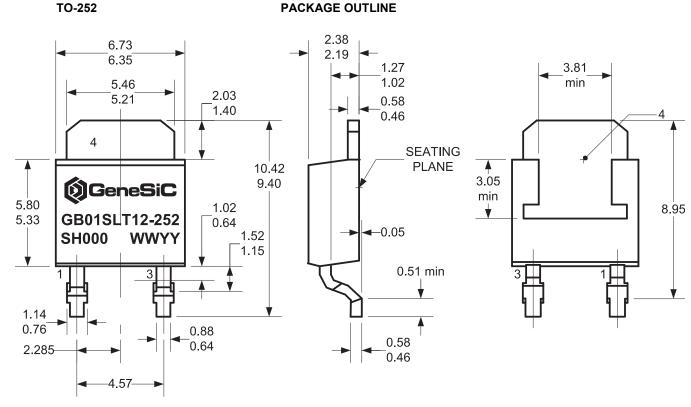


jene

EMICONDUCTOR



Package Dimensions:



NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.

2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

3. CONTROLLED LEAD COPLANARITY <D> 0.004 INCH MAXIMUM



GB01SLT12-252

Revision History							
Date	Revision	Comments	Supersedes				
2013/02/05	2	Second generation update					
2012/05/22	1	Second generation release					
2010/12/13	0	Initial release					

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the GB01SLT12-252 device.

```
*
     MODEL OF GeneSiC Semiconductor Inc.
*
*
     $Revision: 1.0
                                $
*
     $Date: 04-SEP-2013
                                $
*
    GeneSiC Semiconductor Inc.
*
*
     43670 Trade Center Place Ste. 155
*
    Dulles, VA 20166
*
    http://www.genesicsemi.com/index.php/sic-products/schottky
    COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
*
*
     ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of GB01SLT12-252 SPICE Model
.SUBCKT GB01SLT12 ANODE KATHODE
R1 ANODE INT R=((TEMP-24) *0.0069); Temperature Dependant Resistor
D1 INT KATHODE GB01SLT12 25C; Call the 25C Diode Model
D2 ANODE KATHODE GB01SLT12 PIN; Call the PiN Diode Model
.MODEL GB01SLT12 25C D
+ IS
     7.27E-19
                                     0.592251
                          RS
+ N
                         IKF
                                     407.773
         1
+ EG
         1.2
                          XTI
                                     3
+ CJO
         7.90E-11
                                     0.367
                         VJ
+ M
         1.63
                          FC
                                     0.5
+ TT
        1.00E-10
1.00E-03
                          ΒV
                                     1500
+ IBV
                         VPK
                                    1200
+ IAVE
                                    SiC Schottky
         1
                          TYPE
+ MFG GeneSiC Semiconductor
.MODEL GB01SLT12 PIN D
         1.08E-17
                                    1.8
+ IS
                          RS
+ N
         2.2313
                                    999
                         IKF
+ EG
         3.23
                         XTI
                                    -65
+ FC
         0.5
                         TT
                                     0
+ BV
         1500
                         IBV
                                    1.00E-03
+ VPK
         1200
                          IAVE
                                     1
+ TYPE SiC PiN
.ENDS
* End of GB01SLT12-252 SPICE Model
```